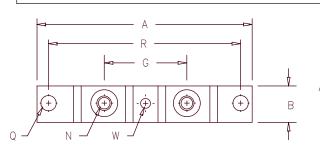
Schottky PowerMod CPT30080—CPT30010C













Notes: Baseplate: Nickel plated copper

Dim. Inches		Millimeters		
Min.	Max.	Min.	Max.	Notes
A B 0.700 C E 0.120 F 0.490 G 1.375	0.630 0.130 0.510	12.45	16.00 3.30 12.95	
H 0.010 N Q 0.275 R 3.15 U 0.600 V 0.312	0.290 0 BSC 0.340	0.25 6.99 80.0	7.37 1 BSC 8.64	1/4-20 Dia.

Microsemi Catalog Number	Industry Part Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
CPT30080*	303CNQ080 MBR30080CT	80V	80V
CPT30090*		90V	90V
CPT300100*	303CNQ0100 MBR300100CT	100V	100V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 300 Amperes/80 to 100 Volts
- 175°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg
Average forward current per leg
Maximum surge current per leg
Maximum repetitive reverse current per leg
Max peak forward voltage per leg
Max peak forward voltage per leg
Max peak reverse current per leg
Max peak reverse current per leg

Typical junction capacitance per leg

| F(AV) 300 Amps | F(AV) 150 Amps | FSM 2000 Amps | R(OV) 2 Amps | VFM 0.98 Volts | VFM .86 Volts | RM 75 mA | RM 4.0 mA | CJ 3000 pF T C = 112°C, Square wave, R OJC = 0.20°C/W T C = 112°C, Square wave, R OJC = 0.40°C/W 8.3ms, half sine, T J = 175°C f C = 1 KHZ, 25°C, 1µsec square wave T FM = 200A: T J = 25°C*

| FM = 200A:T J = 175°C* | VRRM, TJ = 125°C* | VRRM, TJ = 25°C | VR = 5.0V, TC = 25°C

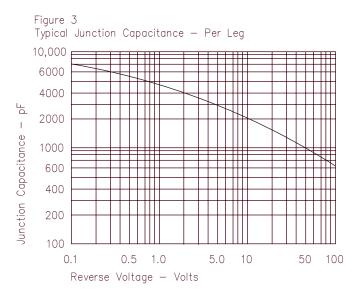
*Pulse test: Pulse width 300µsec, Duty cycle 2%

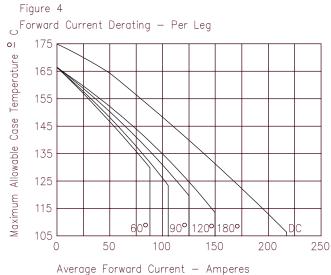
Thermal and Mechanical Characteristics -55℃ to 175℃ TSTG Storage temp range ΤJ Operating junction temp range -55°C to 175°C R OJC Max thermal resistance per leg 0.40°C/W Junction to case ROJC Max thermal resistance per pkg 0.20°C/W Junction to case Typical thermal resistance (greased) Recs 0.08°C/W Case to sink Terminal Torque 35-40 inch pounds Mounting Base Torque (outside holes) Mounting Base Torque (center hole) 30-40 inch pounds 8-10 inch pounds center hole must be torqued first Weight 2.8 ounces (75 grams) typical

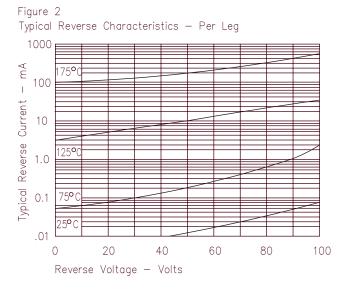


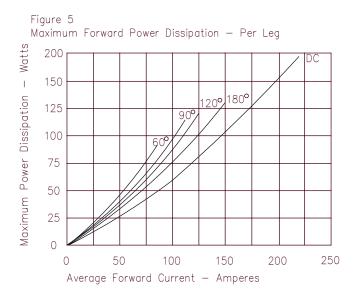
CPT30080-CPT300100

Figure 1 Typical Forward Characteristics — Per Leg 1000 800 600 400 200 100 80 60 40 Amperes 20 I 10 Instantaneous Forward Current 8.0 6.0 4.0 2.0 1.0 0 0.6 0.2 0.4 0.8 1.0 1.2 1.4 Instantaneous Forward Voltage -Volts











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